

## ET1856

### End Termination

#### Description

ET1856 is a solderable & nickel plateable silver/palladium (4:1) end termination designed to be compatible on Multilayer ceramic chip capacitors (NPO and X7R bodies). Nickel plating can be done without pre-plate processing due to the low glass content on the fired surface.

#### Key Features

- Nickel plateable no pre-plate processing
- Low usage excellent coverage uniformity
- Dense fired microstructure Cu plateable



*This picture does not show the packaging of ET1856 and is solely intended for illustration purposes. The products are available in different packaging configurations and may change over time. Please refer to the latest safety data sheets for safety-relevant pictograms.*

#### Typical Properties

Viscosity	30-40 Kcps Brookfield RVTSC4-14 spindle, 6R utility cup at 10 rpm, 25 °C
Alloy Ratio	04:01
Metal	AgPd

#### Recommended Processing Guide

Process Temperature (TDS)	650-800 °C peak temperature. Dwell time of 5-7 minutes at peak.
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